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(54) Title: METHOD FOR DRYING A SEMICONDUCTOR WAFER

(57) Abstract: Disclosed is a method for drying a plate-like article; the method comprising rinsing with an aqueous rinsing liquid with subsequent rinsing with an organic solvent, - wherein the organic solvent has a water content of below 20 mass-% - wherein the organic solvent is supplied at a solvent temperature, which is at least 30°C and not higher than 60°C.